MDA920A1 thru MDA920A9



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Designers Data Sheet

MINIATURE INTEGRAL DIODE ASSEMBLIES

. . . passivated, diffused-silicon dice interconnected and transfer molded into voidless hybrid rectifier circuit assemblies.

• Large Inrush Surge Capability - 45 A (For 1.0 Cycle)

Symbol

VRRM

VRWM

VR

Vdc

Vdc

VR(RMS)

10

IFSM

Tj, Tstg

Efficient Thermal Management Provides Maximum Power Handling
in Minimum Space

Designers Data for "Worst Case" Conditions

The Designers Data Sheet permits the design of most circuits entirely from the information presented. Limit curves – representing boundaries on device characteristics – are given to facilitate "worst case" design.

25 50 100

15 30 62

25 50

18 35 70 140

A1 A2 A3 A4 A5 A6 A7 A8

300 400 600 800

124 185 250 380 500

210 280 420 560

100 200 300 400 600 800

- 1.5

45 for 1 cycle

-55 to +175

Symbol

۷F

۱R

Symbol

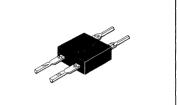
 $R_{\theta JA}$

200

2 3-3-3-3	
<u>*</u> *	

SINGLE-PHASE FULL-WAVE BRIDGE

1.5 AMPERES 25-1000 VOLTS



Unit

Volts

Volte

Amp

Amr

°C

Unit

Volts

μA

Unit

°C/W

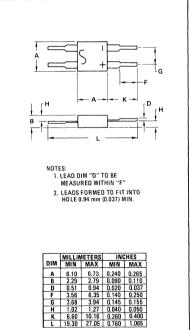
A9

1000

620

1000 Volts

700 Volts



MECHANICAL CHARACTERISTICS

Typical Printed Circuit Board Mounting)

CASE: Transfer-molded plastic encapsulation. POLARITY: Terminal-designation embossed on case +DC output -DC output ~AC input MOUNTING POSITION: Any WEIGHT: 1.0 gram (approx) TERMINALS: Readily solderable connections, corrosion resistant.

Max

1.2

20

Max

50

CASE 109-03

MAXIMUM RATINGS

Rating (Per Leg) Peak Repetitive Reverse Voltage

Working Peak Reverse Voltage

Sine Wave RMS Input Voltage

Average Rectified Forward

(single phase bridge

resistive load, 60 Hz,

see Figure 6, T_A = 50^oC Non-Repetitive Peak Surge Current, (see Figure 2)

rated load, T ι = 175°C

Temperature Range

Operating and Storage Junction

ELECTRICAL CHARACTERISTICS

across ac terminals, T_J = 25^oC) THERMAL CHARACTERISTICS

Effective Bridge Thermal Resistance,

Characteristic

(Per Leg) ($i_F = 2.4 \text{ Amp}, T_J = 25^{\circ}\text{C}$) Figure 1 Maximum Reverse Current (Rated dc Voltage

Characteristic

Junction to Ambient (Full-Wave Bridge Operation

Maximum Instantaneous Forward Voltage Drop

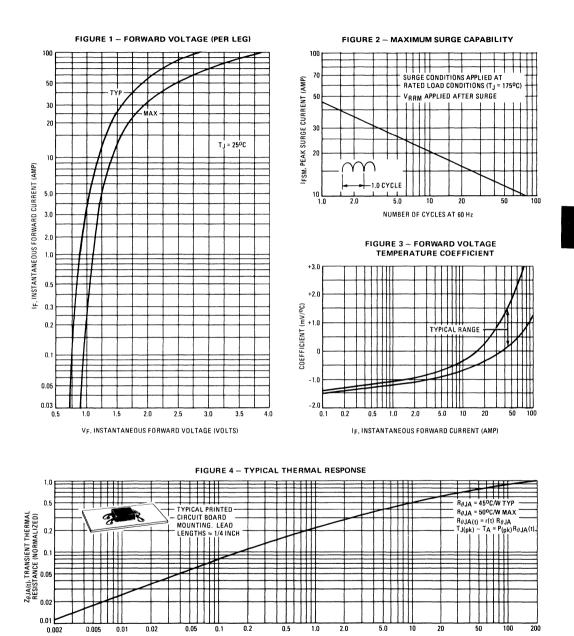
DC Blocking Voltage

DC Output Voltage

Current

Resistive Load

Capacitative Load



t, TIME OR PULSE WIDTH (SECONDS)

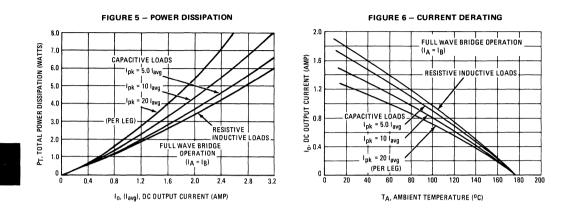
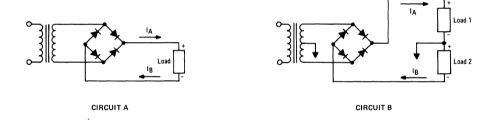


FIGURE 7 - BASIC CIRCUIT USES FOR BRIDGE RECTIFIERS



APPLICATION NOTE

The Data of Figure 4 applies for typical wire terminal or printed circuit board mounting conditions in still air. Under these or similar conditions, the thermal resistance between the diode junctions and the leads at the edge of the case is a small fraction of the thermal resistance from junction to ambient. Consequently, the lead temperature is very close to the junction temperature. Therefore, it is recommended that the lead temperature be measured when the diodes are operating in prototype equipment, in order to determine if operation is within the diode temperature ratings. The lead having the highest thermal resistance to the ambient will yield readings closest to the junction temperature. By measuring temperature as outlined, variations of junction to ambient thermal resistance, caused by the amount of surface area of the terminals or printed circuit board and the degree of air convection, as well as proximity of other heat sources cease to be important design considerations.

Bridge rectifiers are used in two basic circuit configurations as shown by circuits A and B of Figure 7. The current derating data of Figure 6 applies to the standard bridge circuit (A), where $I_A = I_B$. The derating data considers the thermal response of the junction and is based upon the criteria that the junction temperature must not exceed rated T_J(max) when peak reverse voltage is applied. However, because of the slow thermal response and the close thermal response and the close thermal response.

mal coupling between the individual semiconductor die in the MDA920A assembly, the maximum ambient temperature is given closely by

$$T_A = T_J(max) - R_{\theta}JA P_T$$

where P_{T} is the total average power dissipation in the assembly.

For the circuit of Figure B, use of the above formula will yield suitable rating information. For example to determine $T_{A(max)}$ for the conditions:

From Figure 5: For I_A, read P_{TA} \approx 0.8 W For I_B, read P_{TB} \approx 2.2 W

$$P_T = (P_{TA} + P_{TB}) \div 2 = 1.5 W$$

(Division by 2 is necessary as data from Figure 5 is for full-wave bridge operation.) $\therefore T_A(max) = 175^{\circ} - (50) (1.5) = 100^{\circ}C.$

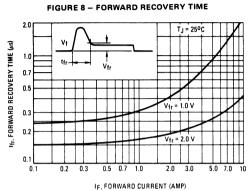


FIGURE 9 – REVERSE RECOVERY TIME

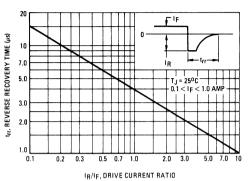
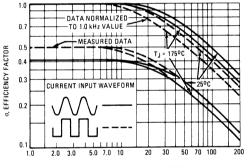
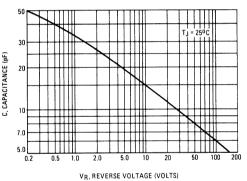


FIGURE 10 - RECTIFICATION WAVEFORM EFFICIENCY



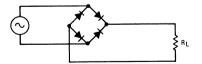
REPETITION FREQUENCY (kHz)

FIGURE 11 - CAPACITANCE



RECTIFIER EFFICIENCY NOTE

FIGURE 12 – SINGLE-PHASE FULL-WAVE BRIDGE RECTIFIER CIRCUIT



The rectification efficiency factor σ shown in Figure 10 was calculated using the formula:

$$\sigma = \frac{P_{(dc)}}{P_{(rms)}} = \frac{\frac{V_{0}^{2}(dc)}{R_{L}}}{\frac{V_{0}^{2}(rms)}{R_{L}}} \cdot 100\% = \frac{V_{0}^{2}(dc)}{V_{0}^{2}(ac) + V_{0}^{2}(dc)} \cdot 100\% (1)$$

For a sine wave input V_m sin (ω t) to the diode, assumed lossless, the maximum theoretical efficiency factor becomes:

$$\sigma_{\text{(sine)}} = \frac{\frac{4 \, \sqrt{2} \, m}{\pi^2 R_{\rm L}}}{\frac{\sqrt{2} \, m}{\sqrt{2} \, m}} \cdot 100\% = \frac{8}{\pi^2} \cdot 100\% = 81.2\%$$
(2)

 $\frac{2R_{L}}{For a square wave} \underset{becomes:}{For a finite of amplitude V_{m'}} \sigma_{(square)} = \frac{\frac{V^{2}_{m}}{R_{L}}}{\frac{V^{2}_{m}}{R_{L}}} \cdot 100\% = 100\%$ (3)

As the frequency of the input signal is increased, the reverse recovery time of the diode (Figure 9) becomes significant, resulting in an increasing ac voltage component across $R_{\rm L}$ which is opposite in polarity to the forward current, thereby reducing the value of the efficiency factor $\sigma,$ as shown on Figure 10.

It should be emphasized that Figure 10 shows waveform efficiency only; it does not provide a measure of diode losses. Data was obtained by measuring the ac component of V_0 with a true mas ac voltmeter and the dc component with a dc voltmeter. The data was used in Equation 1 to obtain points for Figure 10.